

Metrics

- Performance (sec): 1 sec shutter-to-shutter time
- Size (cm²): chip area
- Energy (Joules): Average consumed per shot
- Resolution (pixels): 64 × 64
- SNR (dB): 8 bpp, greyscale

Some metrics are constraints

Other metrics are to be optimized

Design 2: Zero-bias in hardware

SoC approach: 8051 core + EEPROM + RAM + UART + Zero-bias correction peripheral

Most components standard

Custom hardware increases NRE, time-to-market

Fairly simple custom hardware, though

8051 core modified to add special data instructionsa

Zero-bias hardware: controller, memory access control, ALU, counters

First step: Build a model

Need some way of estimating design quality Typical: Build a model in C/C++/SystemC, etc. Helps to analyze power, computational costs, etc.

Often refined into functional model

Used as golden reference

Design 2: Analysis

Entire system coded in VHDL to verify functionality Simulation fast enough to check performance

Synthesizable: used to obtain area estimates

Post-synthesis model used for power estimate

Design 1: Microcontroller Alone

Intel 8051 microcontroller handles all functions Cheap: might be \$5 per chip in quantity

Low-power: 200 mW

Quick to design: about 3 months

Slow: 12 MHz, 12 cycles per instruction, 1 MIPS

Too slow: CCD zero-bias adjustment takes \approx 100 instructions/pixel

4096 pixels takes half a second; compression even more expensive

Design 2: Analysis Results

9.1 s to process an image: *too slow*33 mW power consumption
300 mJ energy consumption (9.1s × 33 mW)
98 000 gates

Simulation shows that processor spends most time performing DCT

Naïve software implementation uses emulated floating-point operations

Better: Use fixed-point arithmetic on the 8051

Design 3: FP DCT + zero-bias HW

Rewrote DCT, otherwise same as Design 2 1.5 s to process an image 33 mW power consumption 50 mJ energy (6× greater battery life) 90 000 gates because code more compact Close, but still not fast enough.

DCT biggest time consumer: implement it in hardware

Design 4: HW DCT + zero-bias

Implement complex 8×8 DCT operation in hardware and simulate again

100 ms to process an image

40 mW power consumption

0.4 mJ energy consumption (12 \times greater than Design 3)

128 000 gates: DCT is a large piece of silicon

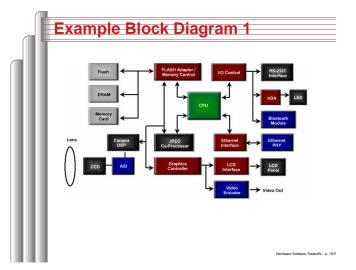
Summary of Designs

	SW	Zero-Bias	FP DCT	HW DCT
Time (s)	≫ 1	9.1	1.5	0.1
Power (mW)		33	33	40
Energy (mJ)		300	50	0.4
Size (kG)		98	90	128

Design 3: FP DCT performance close, cheaper, easier to build

Design 4: HW DCT great performance, energy consumption

Longer to build, may miss market window, may increase IC cost



Example Block Diagram 2 5402 DSK TI 5402 DIGITAL SIONAL PROCESSOR Red Green Blue LCD UNIT NO CONTROLLER McBSP0 ALTERA 3128 44 PLCC MEMORY IF W.BSPO OEWIE/ ALTERA 3128 44 PLCC LATOH (FEO) CMOS IMAGE SENSOR TMERO PC 255Kx16 SAMSUNO 10 ns SRAM 2550x16 SAMSUNO 10 ns SRAM radeoffs – p. 20/

Example Block Diagram 3



Hardware-Software Tradeoffs - p. 21/?